UltraScale+ FPGAs Product Tables and Product Selection Guide







		Device Name	AU10P	AU15P	AU20P	AU25P						
	System	Logic Cells (K)	96	170	238	308						
	CL	B Flip-Flops (K)	88	156	218	282						
		CLB LUTs (K)	44	78	109	141						
	Max. [Dist. RAM (Mb)	1.0	2.5	3.2	4.7						
	Total B	lock RAM (Mb)	3.5	5.1	7.0	10.5						
	36K Blo	ck RAM Blocks	100	144	200	300						
	l	JltraRAM (Mb)	-	_	-	-						
Clo	ock Manageme	nt Tiles (CMTs)	3	3	3	4						
		DSP Slices	400	576	900	1,200						
	PCle	® Gen3 / Gen4	PCIe Gen 4	PCIe Gen 4	PCle Gen 3	PCle Gen 3						
	AMS - S	ystem Monitor	1	1	1	1						
Max. Single-Ended HD I/Os			72	72	72	96						
	Max. Single-	-Ended HP I/Os	156	156	156	208						
		Transceivers ⁽¹⁾		12	_	-						
	GTY 16.3Gb/s	Transceivers ⁽¹⁾	-	–								
		Extended		-1 -2								
		Industrial	-1 -2 -1L									
Footprint ^(2,3)	Dim.	Ball Pitch		HD I/O, HP I/O, GTH, GTY								
Тоогринг	(mm)	(mm)		, .,	o, c, c							
A368	A368 11.5x9.5 0.5 2		24, 104, 8, 0	24, 104, 8, 0								
B484	19x19	0.8	48, 156, 12, 0	48, 156, 12, 0								
B784	23x23	0.8			72, 156, 0, 12	96, 208, 0, 12						
B676	27x27	1.0	72, 156, 12, 0	72, 156, 12, 0	72, 156, 0, 12	72, 208, 0, 12						

^{1.} GTH and GTY transceiver line rates are package limited: SFVB784, SBVB484, and UBVA368 to 12.5Gb/s.12.5Gb/s operation in UBVA368 package is pending characterization.



^{2.} For full part number details, see <u>DS890</u>, *UltraScale Architecture and Product Overview*.

^{3.} Consult <u>UG583</u>, *UltraScale Architecture PCB Design User Guide* for specific migration details.

		Device Name	KU3P	KU5P	KU9P	KU11P	KU13P	KU15P	KU19P
	System	n Logic Cells (K)	356	475	600	653	747	1,143	1,843
Logic	CL	B Flip-Flops (K)	325	434	548	597	683	1,045	1,685
		CLB LUTs (K)	163	217	274	299	341	523	842
	Max. Distribu	uted RAM (Mb)	4.7	6.1	8.8	9.1	11.3	9.8	11.6
Memory	Total B	lock RAM (Mb)	12.7	16.9	32.1	21.1	26.2	34.6	60.8
	ι	UltraRAM (Mb)	13.5	18.0	0	22.5	31.5	36.0	81.0
Clocking	Clock Mgr	mt Tiles (CMTs)	4	4	4	8	4	11	9
		DSP Slices	1,368	1,824	2,520	2,928	3,528	1,968	1,080
Integrated	PCIE4 (PC	Cle® Gen3 x16)	1	1	0	4	0	5	0
IP	•	Cle® Gen3 x16 / Gen4 x8 /CCIX)	0	0	0	0	0	0	3
	1	50G Interlaken	0	0	0	1	0	4	0
	100G Ethernet	hernet w/ KR4 RS-FEC 0		1	0	2	0	4	1
	Max. Single-	Ended HD I/Os	96	96	96	96	96	96	72
I/O	Max. Single-	-Ended HP I/Os	208	208	208	416	208	572	468
1/0	GTH 16.3Gb	/s Transceivers	0	0	28	32	28	44	0
	GTY 32.75Gb	/s Transceivers	16	16	0	20	0	32	32
Speed Grades		Extended ⁽¹⁾	-1 -2 -2L -3	-1 -2 -2L -3	-1 -2 -2L -3	-1 -2 -2L -3			
speed Grades		Industrial	-1 -1L -2	-1 -1L -2	-1 -1L -2	-1 -1L -2	-1 -1L -2	-1 -1L -2	-1 -1L -2
		Dimensions (mm)			HD I/O,	HP I/O, GTH 16.3Gb/s, GTY	32.75Gb/s		
ier	B784 ⁽⁴⁾	23x23 ⁽⁵⁾	96, 208, 0, 16	96, 208, 0, 16					
entif	A676 ⁽⁴⁾	27x27	48, 208, 0, 16	48, 208, 0, 16					
Onm int ia	B676	27x27	72, 208, 0, 16	72, 208, 0, 16					
ith 2.	D900 ⁽⁴⁾	31x31	96, 208, 0, 16	96, 208, 0, 16		96, 312, 16, 0			
ble w me fa	E900	31x31			96, 208, 28, 0		96, 208, 28, 0		
Footprint compatible with 20nm UltraScale Devices with same footprint identifier	A1156 ⁽⁴⁾	35x35				48, 416, 20, 8		48, 468, 20, 8	
	E1517	40x40				96, 416, 32, 20		96, 416, 32, 24	
	A1760	42.5x42.5						96, 416, 44, 32	
Foo cale L	E1760	42.5x42.5						96, 572, 32, 24	
traScı	J1760 42.5x42.5								72, 468, 0, 32
5	B2104	47.5x47.5							72, 468, 0, 32

^{1. -2}LE (Tj = 0°C to 110°C). For more details, see the Ordering Information section in DS890, UltraScale Architecture and Product Overview.

^{4.} GTY transceiver line rates are package limited: B784 to 12.5 Gb/s; A676, D900, and A1156 to 16.3 Gb/s. Refer to data sheet for details.



^{2.} Maximum achievable performance is device and package dependent; consult the associated data sheet for details.

^{3.} For full part number details, see the Ordering Information section in DS890, UltraScale Architecture and Product Overview.

		_				58G PAM4						
		Device Name	VU3P	VU5P	VU7P	VU9P	VU11P	VU13P	VU19P	VU23P	VU27P	VU29P
· ·		m Logic Cells (K)	862	1,314	1,724	2,586	2,835	3,780	8,938	2,252	2,835	3,780
•		LB Flip-Flops (K)	788	1,201	1,576	2,364	2,592	3,456	8,172	2,059	2,592	3,456
		CLB LUTs (K)	394	601	788	1,182	1,296	1,728	4,086	1,030	1,296	1,728
	Max.	Dist. RAM (Mb)	12.0	18.3	24.1	36.1	36.2	48.3	58.4	14.2	36.2	48.3
	Total I	Block RAM (Mb)	25.3	36.0	50.6	75.9	70.9	94.5	75.9	74.3	70.9	94.5
		UltraRAM (Mb)	90.0	132.2	180.0	270.0	270.0	360.0	90.0	99.0	270.0	360.0
		DSP Slices	2,280	3,474	4,560	6,840	9,216	12,288	3,840	1,320	9,216	12,288
	Peak IN	NT8 DSP (TOP/s)	7.1	10.8	14.2	21.3	28.7	38.3	10.4	4.1	28.7	38.3
		PCle® Gen3 x16	2	4	4	6	3	4	0	0	1	1
F		Gen4 x8 / CCIX ⁽¹⁾	-	-	-	_	_	-	8	4	-	-
		150G Interlaken	3	4	6	9	6	8	0	0	8	8
		t w/ KR4 RS-FEC	3	4	6	9	9	12	0	2	15	15
		e-Ended HP I/Os	520	832	832	832	624	832	1,976	572	676	676
		e-Ended HD I/Os	0	0	0	0	0	0	96	72	0	0
		b/s Transceivers	40	80	80	120	96	128	80	34	32	32
G		M4 Transceivers	-	-	-	_	_	-	-	4	48	48
		G / 50G KP4 FEC	-	-	-	-	-	-	-	2/4	24 / 48	24 / 48
		Extended ⁽²⁾	-1 -2 -2L -3	-1 -2	-1 -2 -2L -3	-1 -2 -2L -3	-1 -2 -2L -3					
		Industrial	-1 -2	-1 -2	-1 -2	-1 -2	-1 -2	-1 -2	_	-1, -2	-1 -2	-1 -2
F	ootprint ^(3,4,5)	Dim. (mm)			HP I/0	O, GTY			HP I/O, HD I/O, GTY	HP I/O, HD I/O, GTY, GTM		
	A1365 ⁽⁴⁾	35x35								364, 0, 34 ⁽⁸⁾ , 4		
	C1517	40x40	520, 40									
7	J1760	42.5x42.5								572, 72, 34, 4		
ntifie	F1924 ⁽⁶⁾	45x45					624, 64					
n idei		47.5x47.5		832, 52	832, 52	832, 52	,					
20ni orint	A2104	52.5x52.5 ⁽⁷⁾		332,32	332,32	002,02		832, 52				
: with 20nm : footprint identifie		47.5x47.5		702, 76	702, 76	702, 76	572, 76	032, 32				
ble v	B2104	52.5x52.5 ⁽⁷⁾		702,70	702,70	702,70	372,70	702, 76				
ipati th sa		47.5x47.5		416, 80	416, 80	416, 104	416, 96	702, 70				
con s wit	C2104	52.5x52.5 ⁽⁷⁾		410, 80	410, 80	410, 104	410, 30	416, 104				
rint vice						676.76	570.76	410, 104				
ootp e De	D2104	47.5x47.5				676, 76	572, 76					
Fe		52.5x52.5 ⁽⁷⁾						676, 76			676, 16, 30	676, 16, 30
Footprint compatible UltraScale Devices with same	H2104	47.5x47.5										
٦	A2577	52.5x52.5				448, 120	448, 96	448, 128			448, 32, 48	448, 32, 48
	A3824	65x65							1976, 96,48			
	B3824	65x65							1664, 96, 80			

^{1.} This block operates in compatibility mode for 16.0GT/s (Gen4) operation. See PG213.

XMP103 (v2.0) **E** XILINX

^{2. -2}LE (Tj = 0°C to 110°C). See Ordering Information in DS890.

^{3.} For full part number details, see DS890, UltraScale Architecture and Product Overview.

^{4.} All packages are 1.0mm ball pitch, with the exception of A1365, which is 0.92mm.

^{5.} Consult <u>UG583</u>, *UltraScale Architecture PCB Design User Guide* for specific migration details.

^{6.} The GTY transceiver line rate in the F1924 footprint is package limited to 16.3Gb/s. Refer to data sheet for details.

^{7.} These 52.5x52.5mm packages have the same PCB ball footprint as the 47.5x47.5mm packages and are footprint compatible. 8. GTYs in quads 224-230 and 232 are limited to 16Gb/s.

		HBM (4GB)		HBM (8GB)			HBM (16GB)					
Device Name_		VU31P	VU33P	VU35P	VU37P	VU45P	VU47P	VU57P				
	System Logic Cells (K)		962	1,907	2,852	1,907	2,852	2,852				
	CLB Flip-Flops (K)		879	1,743	2,607	1,743	2,607	2,607				
	CLB LUTs (K)	440	440	872	1,304	872	1,304	1,304				
	Max. Dist. RAM (Mb)	12.5	12.5	24.6	36.7	24.6	36.7	36.7				
	Total Block RAM (Mb)	23.6	23.6	47.3	70.9	47.3	70.9	70.9				
	UltraRAM (Mb)	90.0	90.0	180.0	270.0	180.0	270.0	270.0				
	HBM DRAM (GB)	4	8	8	8	16	16	16				
	HBM AXI Interfaces	32	32	32	32	32	32	32				
Clo	ock Mgmt Tiles (CMTs)	4	4	8	12	8	12	12				
	DSP Slices	2,880	2,880	5,952	9,024	5,952	9,024	9,024				
I	Peak INT8 DSP (TOP/s)		8.9	18.6	28.1	18.6	28.1	28.1				
	PCIe® Gen3 x16	0	0	1	2	1	2	0				
PCIe Gen	3 x16/Gen4 x8 / CCIX ⁽¹⁾	4	4	4	4	4	4	4				
	150G Interlaken	0	0	2	4	2	4	4				
100G Et	thernet w/ KR4 RS-FEC	2	2	5	8	5	8	10				
Max	. Single-Ended HP I/Os	208	208	416	624	416	624	624				
GTY 3	2.75Gb/s Transceivers	32	32	64	96	64	96	32				
GTM 58Gb	o/s PAM4 Transceivers	-	-	-	-	-	-	32				
	100G / 50G KP4 FEC	-	-	-	-	-	-	16/32				
	Extended ⁽²⁾	-1 -2 -2L -3										
	Industrial	_	-	-	-	-		-				
Footprint ^(3, 4, 5, 6)	Dim. (mm)			HP I/O	D, GTY			HP I/O, GTY, GTM				
H1924	45x45	208, 32										
H2104	47.5x47.5		208, 32	416, 64		416, 64						
H2892	55x55			416, 64	624, 96	416, 64	624, 96					
K2892 55x55								624, 32, 32				

^{1.} This block operates in compatibility mode for 16.0GT/s (Gen4) operation. See PG213.

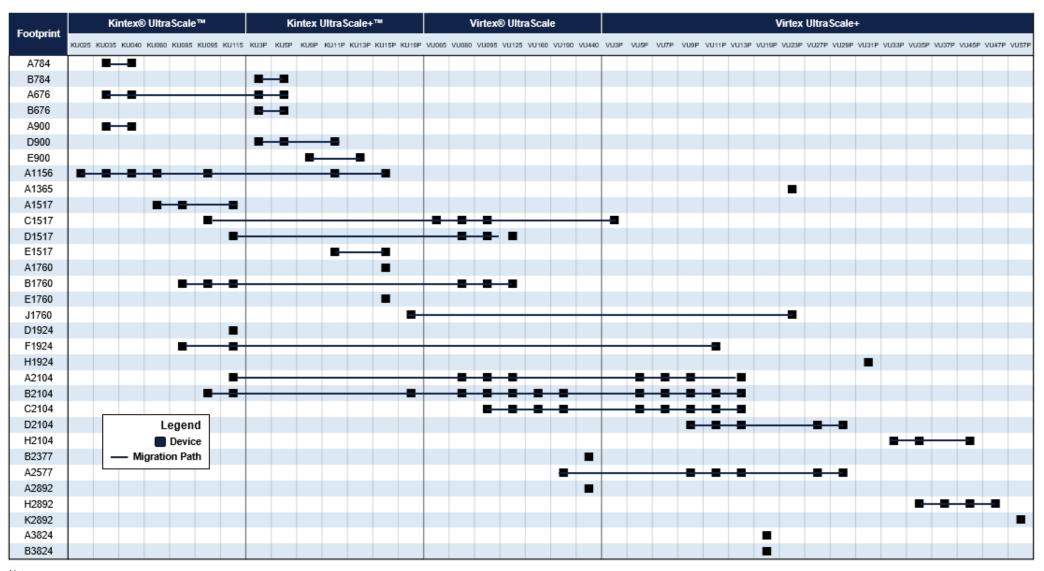
 ⁻²LE (Tj = 0°C to 110°C). See Ordering Information in DS890.
 For full part number details, see DS890, *UltraScale Architecture and Product Overview*.

^{4.} All packages are 1.0mm ball pitch.

^{5.} Consult <u>UG583</u>, *UltraScale Architecture PCB Design User Guide* for specific migration details.

^{6.} Footprint compatible with 20nm UltraScale Devices with same footprint identifier.

UltraScale Architecture Migration Table



Notes

^{1.}The body size of the VU13P device in the A2104, B2104, C2104, and D2104 packages is 52.5mm. These packages are footprint compatible with the corresponding 47.5mm body size packages. See <u>UG583</u>, *UltraScale Architecture PCB Design User Guide* for important migration details.

^{2.} Virtex UltraScale+ HBM devices migrate among each other but do not migrate to other devices.

Artix® UltraScale+™ FPGA Speed Grades

Device Name⁽¹⁾

	Speed Grade	AU10P	AU15P	AU20P	AU25P
papu	-1	•	•	•	•
Extended	-2	•	•	•	•
	-1	•	•	•	•
Industrial	-1L	•	•	•	•
<u>-</u>	-2	•	•	•	•

Motoc

1. For full part number details, see the Ordering Information section in DS890, UltraScale Architecture and Product Overview.

• :: available

- :: not offered



Kintex® UltraScale+™ FPGA Speed Grades

Device Name⁽¹⁾

	Speed Grade	KU3P	KU5P	KU9P	KU11P	KU13P	KU15P	KU19P
G	-1	•	•	•	•	•	•	•
Extended ⁽²⁾	-2	•	•	•	•	•	•	•
xten	-2L	•	•	•	•	•	•	•
Ш	-3	•	•	•	•	•	•	•
ia	-1	•	•	•	•	•	•	•
Industrial	-1L	•	•	•	•	•	•	•
<u>I</u>	-2	•	•	•	•	•	•	•

Notes:

For full part number details, see the Ordering Information section in <u>DS890</u>, *UltraScale Architecture and Product Overview*.
 For more details, see the Ordering Information section in <u>DS890</u>, *UltraScale Architecture and Product Overview*.

:: available- :: not offered

Virtex® UltraScale+™ FPGA Speed Grades

Device Name⁽¹⁾

	Speed Grade	VU3P	VU5P	VU7P	VU9P	VU11P	VU13P	VU19P	VU23P	VU27P	VU29P	VU31P	VU33P	VU35P	VU37P	VU45P	VU47P	VU57P
G:	-1	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•
Extended ⁽²⁾	-2	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•	•
xten	-2L	•	•	•	•	•	•	-	•	•	•	•	•	•	•	•	•	•
ш	-3	•	•	•	•	•	•	_	•	•	•	•	•	•	•	•	•	•
trial	-1	•	•	•	•	•	•	-	•	•	•	-	_	_	-	-	-	-
Industrial	-2	•	•	•	•	•	•	-	•	•	•	-	-	-	_	_	_	_

Notes:

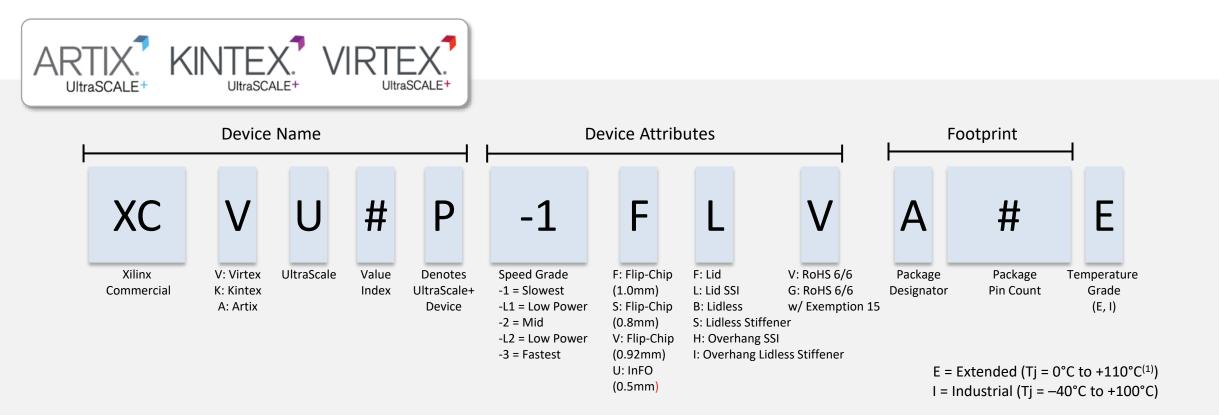
1. For full part number details, see the Ordering Information section in DS890, UltraScale Architecture and Product Overview.

2.-2LE (Tj = 0°C to 110°C). For more details, see the Ordering Information section in DS890, UltraScale Architecture and Product Overview.

:: available- :: not offered



UltraScale+ Device Ordering Information



Notes:

1. For more details on 110°C operation, see the Ordering Information section in DS890, UltraScale Architecture and Product Overview

For valid part/package combinations, go to <u>DS890</u>, *UltraScale Architecture and Product Overview:* Device-Package Combinations and Maximum I/Os Tables



References



- DS890, UltraScale™ Architecture and Product Overview
- DS922, Kintex® UltraScale+™ FPGAs Data Sheet: DC and AC Switching Characteristics
- DS923, Virtex UltraScale+ FPGA Data Sheet: DC and AC Switching Characteristics
- UG570, UltraScale Architecture Configuration User Guide
- <u>UG571</u>, UltraScale Architecture SelectIO™ Resources User Guide
- UG572, UltraScale Architecture Clocking Resources User Guide
- UG573, UltraScale Architecture Memory Resources User Guide
- <u>UG574</u>, UltraScale Architecture Configurable Logic Block User Guide
- UG575, UltraScale and UltraScale+ FPGAs Packaging and Pinouts Product Specification
- UG576, UltraScale Architecture GTH Transceivers User Guide
- UG578, UltraScale Architecture GTY Transceivers User Guide
- UG579, UltraScale Architecture DSP Slice User Guide
- <u>UG580</u>, UltraScale Architecture System Monitor User Guide
- UG583, UltraScale Architecture PCB Design User Guide
- PG150, UltraScale Architecture-Based FPGAs Memory IP Product Guide
- PG182, UltraScale FPGAs Transceivers Wizard Product Guide

